

LNPTTM THERMOCOMPTM COMPOUND MF006SXP

MFX-1006

REGION EUROPE

DESCRIPTION

LNP THERMOCOMP MF006SXP compound is based on Polypropylene (PP) resin containing 30% glass fiber. Added features of this grade include: Heat Stabilized.

GENERAL INFORMATION

Features	Heat Stabilized, High stiffness/Strength, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Polypropylene, Unspecified (PP, Unspecified)
Processing Techniques	Injection Molding

INDUSTRY

Consumer
Electrical and Electronics
Industrial

SUB INDUSTRY

Sport/Leisure, Personal Accessory
Mobile Phone - Computer - Tablets
Electrical

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, yield, 50 mm/min	81	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	2.6	%	ISO 527
Tensile Modulus, 1 mm/min	5700	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	105	MPa	ISO 178
Flexural Modulus, 2 mm/min	5100	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, unnotched 80*10*4 +23°C	35	kJ/m ²	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	9	kJ/m ²	ISO 180/1A
THERMAL ⁽¹⁾			
CTE, 23°C to 60°C, flow	3.5E-05	1/°C	ISO 11359-2
CTE, 23°C to 60°C, xflow	1.26E-04	1/°C	ISO 11359-2
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	136	°C	ISO 75/Af
Relative Temp Index, Elec ⁽²⁾	65	°C	UL 746B
Relative Temp Index, Mech w/impact ⁽²⁾	65	°C	UL 746B
Relative Temp Index, Mech w/o impact ⁽²⁾	65	°C	UL 746B
PHYSICAL ⁽¹⁾			
Density	1.13	g/cm ³	ISO 1183
ELECTRICAL ⁽¹⁾			
Comparative Tracking Index (UL) {PLC}	0	PLC Code	UL 746A
Hot-Wire Ignition (HWI), PLC 2	≥3	mm	UL 746A

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CHEMISTRY THAT MATTERS™

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Hot-Wire Ignition (HWI), PLC 3	≥1	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 1	≥1.5	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 3	≥1	mm	UL 746A
High Voltage Arc Track Rate {PLC}	1	PLC Code	UL 746A
Arc Resistance, Tungsten {PLC}	6	PLC Code	ASTM D495
FLAME CHARACTERISTICS ⁽²⁾			
UL Yellow Card Link	<u>E45329-101283862</u>	-	-
UL Recognized, 94HB Flame Class Rating	≥1	mm	UL 94
INJECTION MOLDING ⁽³⁾			
Drying Temperature	80	°C	
Drying Time	4	Hrs	
Melt Temperature	225 – 250	°C	
Front - Zone 3 Temperature	240 – 250	°C	
Middle - Zone 2 Temperature	215 – 225	°C	
Rear - Zone 1 Temperature	195 – 205	°C	
Mold Temperature	30 – 50	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.

(3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

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